

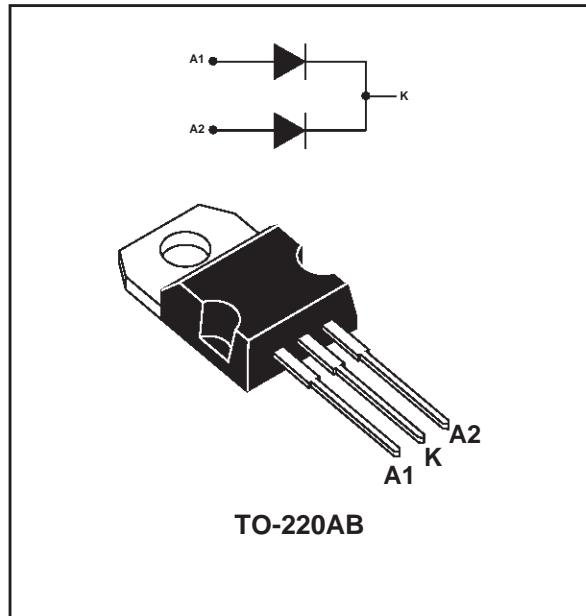
## ULTRA-FAST RECOVERY RECTIFIER DIODES

### MAIN PRODUCTS CHARACTERISTICS

$I_{F(AV)}$	2 x 12 A
$V_{RRM}$	200 V
$T_j(\max)$	150°C
$V_F(\max)$	0.99 V
$t_{rr}(\max)$	30 ns

### FEATURES

- SUITED FOR SMPS
- LOW LOSSES
- LOW FORWARD AND REVERSE RECOVERY TIME
- HIGH SURGE CURRENT CAPABILITY
- HIGH AVALANCHE ENERGY CAPABILITY



Low cost dual center tap rectifier suited for Switch Mode Power Supply and high frequency DC to DC converters.

Packaged in TO-220AB, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.

Symbol	Parameter		Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage		200	V
$I_{F(RMS)}$	RMS forward current		30	A
$I_{F(AV)}$	$\delta = 0.5$	$T_c = 115^\circ\text{C}$	Per diode	A
			Per device	
$I_{FSM}$	$T_p = 10 \text{ ms}$ Sinusoidal		120	A
$T_{stg}$	Storage temperature range		- 65 to + 150	$^\circ\text{C}$
$T_j$	Maximum operating junction temperature		+ 150	

# STPR2420CT

## THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case	Per diode Total	2.5 1.4	$^{\circ}\text{C}/\text{W}$
$R_{th(c)}$		Coupling	0.23	

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_j(\text{diode } 1) = P(\text{diode } 1) \times R_{th(j-c)} (\text{Per diode}) + P(\text{diode } 2) \times R_{th(c)}$$

## STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameters	Test conditions		Min.	Typ.	Max.	Unit
$I_R$ *	Reverse leakage current	$T_j = 25^{\circ}\text{C}$	$V_R = V_{RRM}$			50	$\mu\text{A}$
		$T_j = 100^{\circ}\text{C}$				0.8	$\text{mA}$
$V_F$ **	Forward voltage drop	$T_j = 125^{\circ}\text{C}$	$I_F = 12 \text{ A}$			0.99	$\text{V}$
		$T_j = 125^{\circ}\text{C}$	$I_F = 24 \text{ A}$			1.20	
		$T_j = 25^{\circ}\text{C}$	$I_F = 24 \text{ A}$			1.25	

Pulse test : \*  $t_p = 5 \text{ ms}, \delta < 2\%$

\*\*  $t_p = 380 \mu\text{s}, \delta < 2\%$

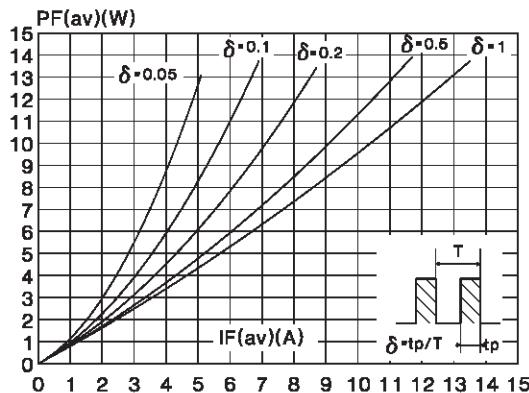
To evaluate the conduction losses use the following equation:

$$P = 0.78 \times I_{F(AV)} + 0.0175 \times I_F^2(\text{RMS})$$

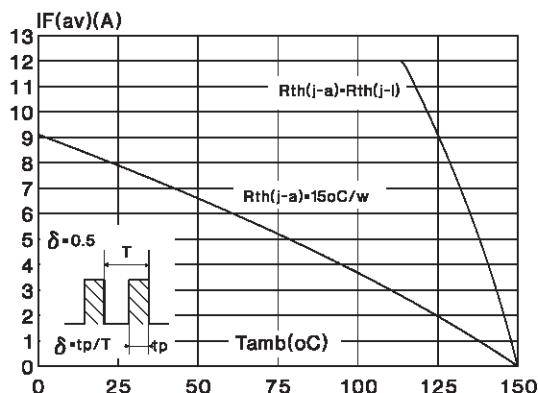
## RECOVERY CHARACTERISTICS

Symbol	Test conditions			Min.	Typ.	Max.	Unit
$trr$	$T_j = 25^{\circ}\text{C}$	$I_F = 0.5\text{A}$	$I_{rr} = 0.25\text{A}$	$I_R = 1\text{A}$		30	$\text{ns}$
$tfr$	$T_j = 25^{\circ}\text{C}$	$I_F = 1\text{A}$	$tr = 10 \text{ ns}$	$V_{FR} = 1.1 \times V_F$		20	
$V_{FP}$	$T_j = 25^{\circ}\text{C}$	$I_F = 1\text{A}$	$tr = 10 \text{ ns}$			3	$\text{V}$

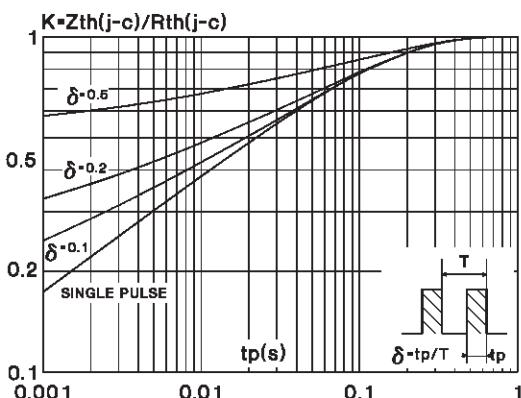
**Fig. 1:** Average forward power dissipation versus average forward current (per diode).



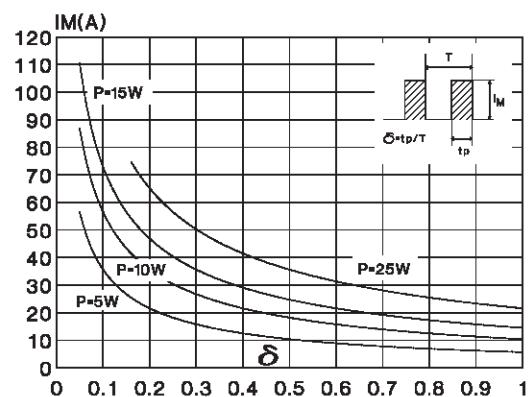
**Fig. 3:** Average current versus ambient temperature.



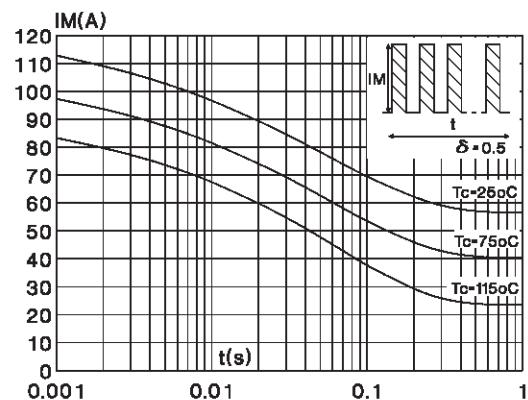
**Fig. 5:** Relative variation of thermal transient impedance junction to case versus pulse duration.



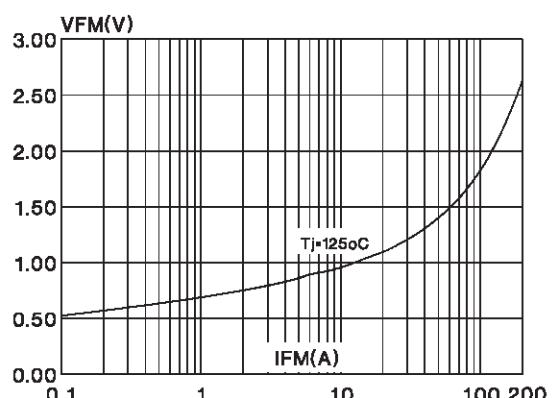
**Fig. 2:** Peak current versus form factor (per diode).



**Fig. 4:** Non repetitive surge peak forward current versus overload duration (maximum values).



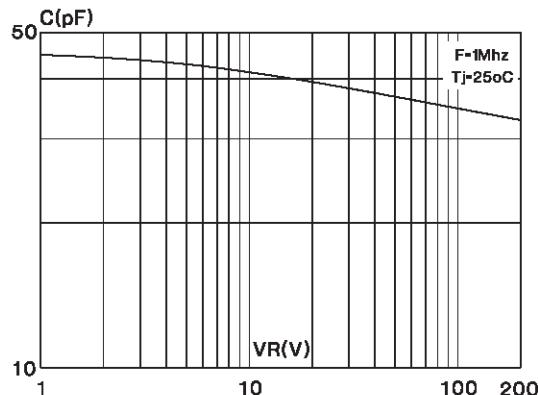
**Fig. 6:** Forward voltage drop versus forward current.



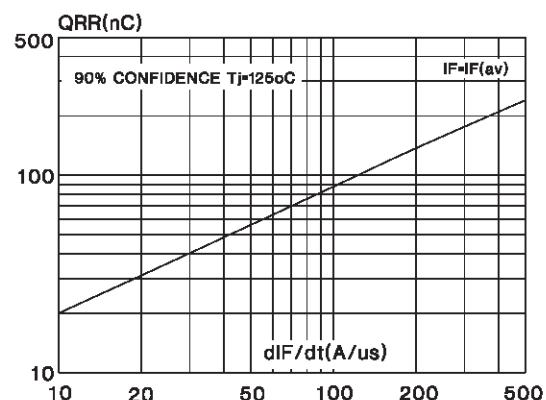
## STPR2420CT

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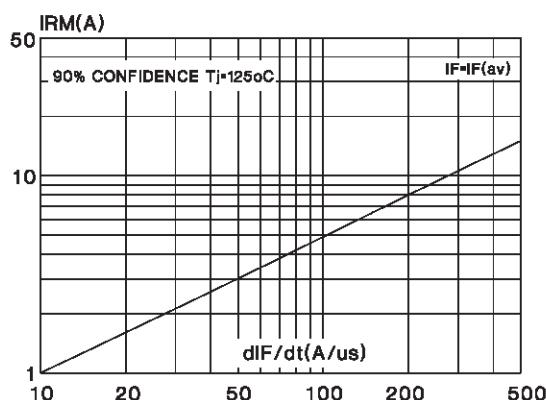
**Fig. 7:** Junction capacitance versus reverse voltage applied (typical values, per diode).



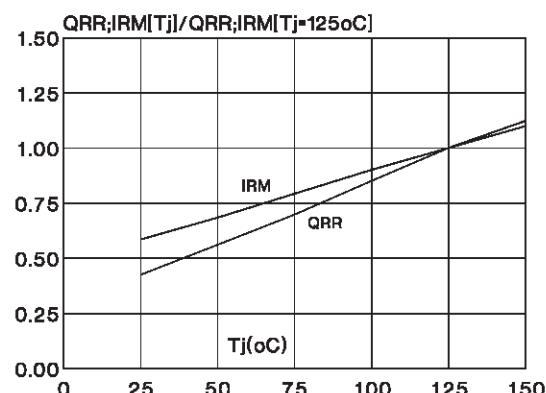
**Fig. 8:** Recovery charge versus  $dI_F/dt$  (per diode).



**Fig. 9:** Peak reverse current versus  $dI_F/dt$  (per diode).

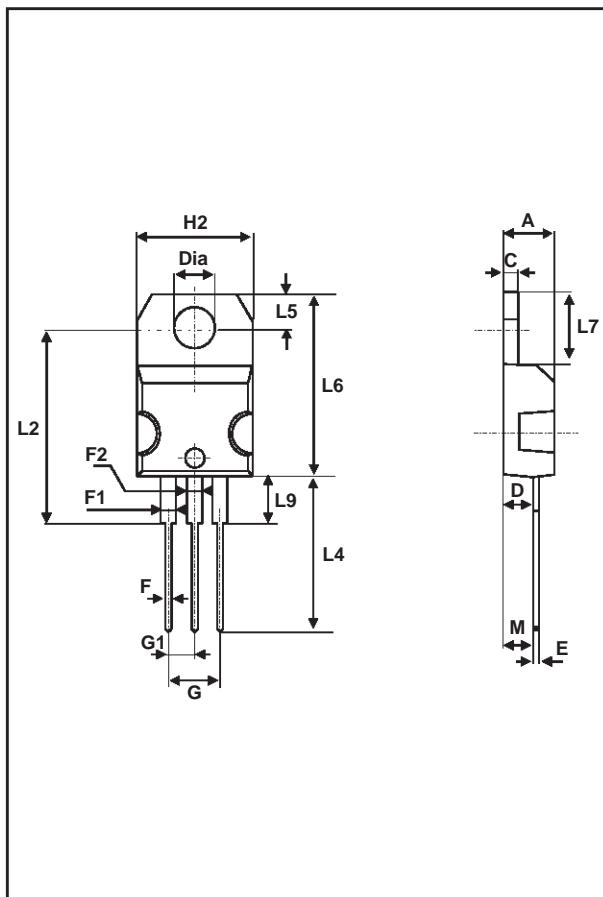


**Fig. 10:** Dynamic parameters versus junction temperature (per diode).



## PACKAGE MECHANICAL DATA

TO-220AB



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
C	1.23	1.32	0.048	0.051
D	2.40	2.72	0.094	0.107
E	0.49	0.70	0.019	0.027
F	0.61	0.88	0.024	0.034
F1	1.14	1.70	0.044	0.066
F2	1.14	1.70	0.044	0.066
G	4.95	5.15	0.194	0.202
G1	2.40	2.70	0.094	0.106
H2	10	10.40	0.393	0.409
L2	16.4 typ.		0.645 typ.	
L4	13	14	0.511	0.551
L5	2.65	2.95	0.104	0.116
L6	15.25	15.75	0.600	0.620
L7	6.20	6.60	0.244	0.259
L9	3.50	3.93	0.137	0.154
M	2.6 typ.		0.102 typ.	
Diam.	3.75	3.85	0.147	0.151

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